12-01-04



Hw.

AME	1	Docket No. 03310/034001				
Applicatio 10/693,842-Co		Filing 8 October 2		Examiner Patricia H. Hight		Art Unit 1711
Applicant(s): Mamiko Nomura et al.						
nvention: RESIN COMPOSITIONS, PROCESSES FOR PREPARING THE RESIN COMPOSITIONS AND PROCESSES FOR FORMING RESIN FILMS						
TO THE COMMISSIONER FOR PATENTS						
Transmitted herewith is an amendment in the above-identified application.  The fee has been calculated and is transmitted as shown below.						
CLAIMS AS AMENDED						
	Claims Remaining After Amendment	Highest Number Previously Paid	Number Extra Claims Present			
Total Claims	7	- 20 =	11000	X		0.00
Independent Claims	4	- 4 =	1	х		0.00
Multiple Dependent Claims (check if applicable)						
Other fee (please specify):						
TOTAL ADDIT	TIONAL FEE FO	OR THIS AME	NDMENT:			0.00
No additional fee is required for this amendment.   Please charge Deposit Account No in the amount of \$ A duplicate copy of this sheet is enclosed.   A check in the amount of \$ to cover the filing fee is enclosed.   Payment by credit card. Form PTO-2038 is attached.     X The Director is hereby authorized to charge and credit Deposit Account No 50-0591   as described below. A duplicate copy of this sheet is enclosed.     Credit any overpayment.     X Charge any additional filing or application processing fees required under 37 CFR 1.16 and 1.17.   Dated: November 30, 2004     November 30, 2004     November 30, 2004     November 30, 2004     November 37, 2004     November 37, 2005     November 37, 2006     November 37, 2007     November 37, 2007						
in an envelope address shown below.	ised to: MS Amendin	ment, Commissioner	er for Patents, P.O.	al Service as Express Mail, D. Box 1450, Alexandria, V.	/A 22313-145	V 576721165 US. 50, on the date
Dated: November 30, 2	2004	Signature: // / /	11 Y C	WIXXXX (LISA)	H. Smith)	